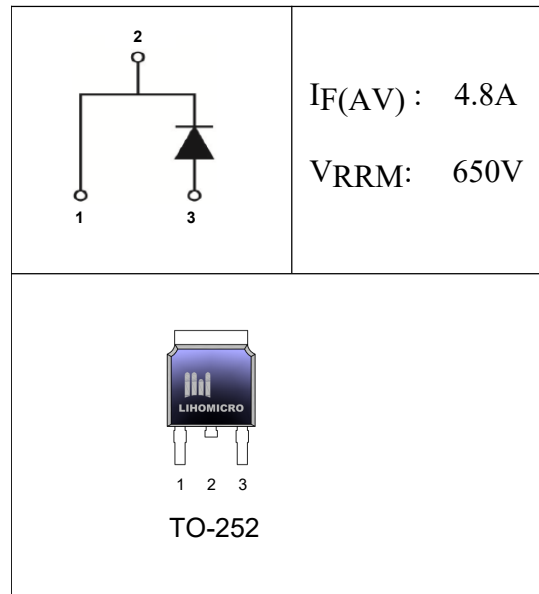


●Features

- High Surge Current Capacity
- Low Forward Voltage Drop
- Low Power Loss & High Efficiency
- Guard Ring & Environmental Protection
- High Temperature Application
- Green Molding Compound(No Br,Sb)

●Application

- Half-Bridge/Full-Bridge Switched-Mode Power
- PC Power


●Ordering Information:

Part Number	LHC04A65
Package	TO-252
Basic Ordering Unit (pcs)	5000
Normal Package Material Ordering Code	LHC04A65T5-TO252-TAP
Halogen Free Ordering Code	LHC04A65T5-TO252-TAP

●Maximum Ratings Characteristics ($T_A = 25^\circ\text{C}$ Unless otherwise Noted)

PARAMETER	SYMBOL	Value	UNIT
Repetitive Peak Reverse Voltage	VRRM	650	V
Working Peak Reverse Voltage	V_{RWM}	650	V
DC blocking Voltage	V_{RM}	650	V
Average Rectified Forward Current (Rated VR-20KHz Square Wave)-50% duty cycle	IF(AV)	4.8	A
Repetitive Peak Forward surge current (surge applied at rated load conditions half wave, single phase, 60Hz)	I_{FSM}	48	A
Operating Temperature	T_J	-55~+175	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55~+175	$^\circ\text{C}$

●Electronic Characteristics

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Forward Voltage Drop	VF	$I_F=4A, T_J=25^{\circ}C$	--	1.5	1.8	V
		$I_F=4A, T_J=175^{\circ}C$	--	1.8	2.0	
Reverse Current	IR	$V_R=V_{RRM}, T_J=25^{\circ}C$	--	1	20	uA
		$V_R=V_{RRM}, T_J=175^{\circ}C$	--	12	100	nA
Total Capacitive Charge	Qc	$V_R = 400 V, T_J = 25^{\circ}C$	--	28	--	nC
Total Capacitance	C _T	$V_R=0V, T_J=25^{\circ}C, f=1MHz$	--	185	--	pF
		$V_R=200V, T_J=25^{\circ}C, f=1MHz$	--	19	--	
		$V_R=400V, T_J=25^{\circ}C, f=1MHz$	--	67	--	
Capacitance Stored Energy	Ec	$V_R=400V$	--	2.4	--	μJ

●Thermal Characteristics

PARAMETER	SYMBOL	MAX	UNIT
Thermal Resistance Junction-case	Rth _{JC}	2.4	°C/W

Note:

1.300Us pulse width 2% duty cycle

2.Thermal Resistance test performed in accordance with JESD-51

●Ratings and Characteristics Curves

Figure 1. Forward Characteristics

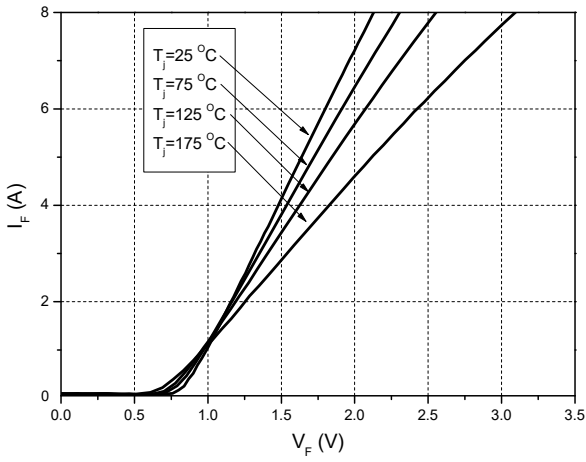


Figure 2. Reverse Characteristics

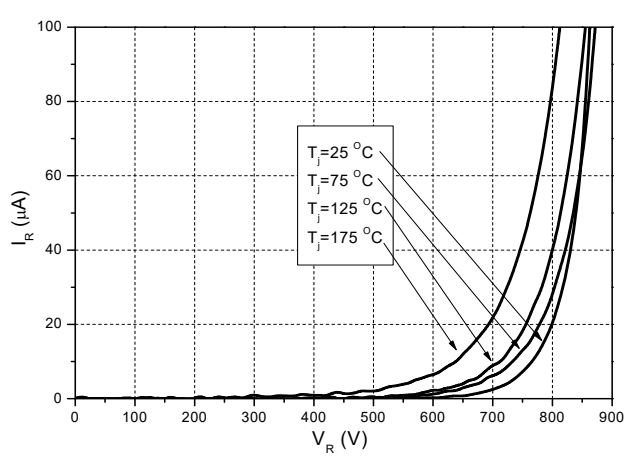


Figure 3. Capacitance vs. Reverse Voltage

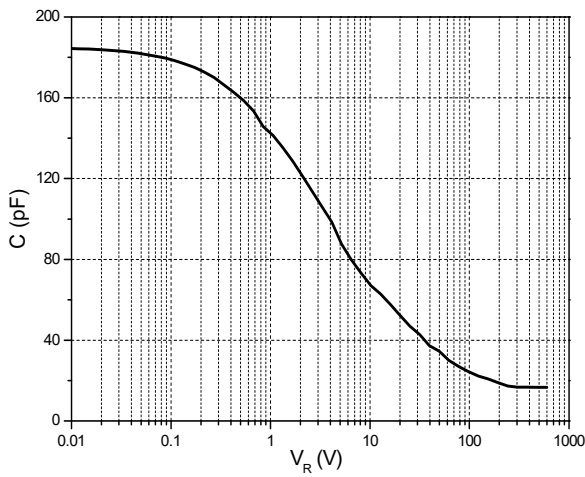
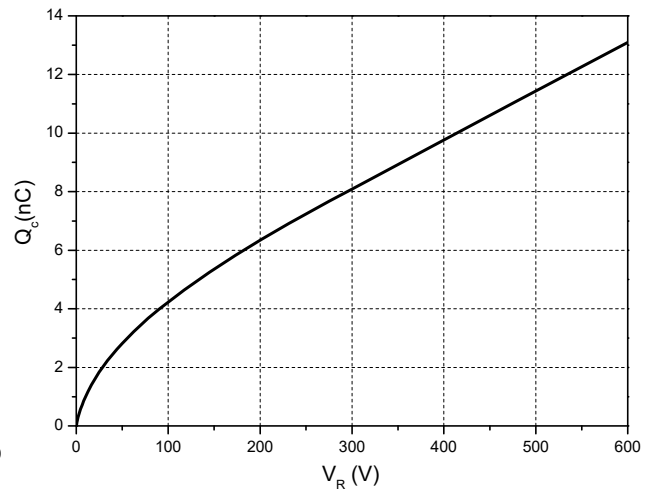


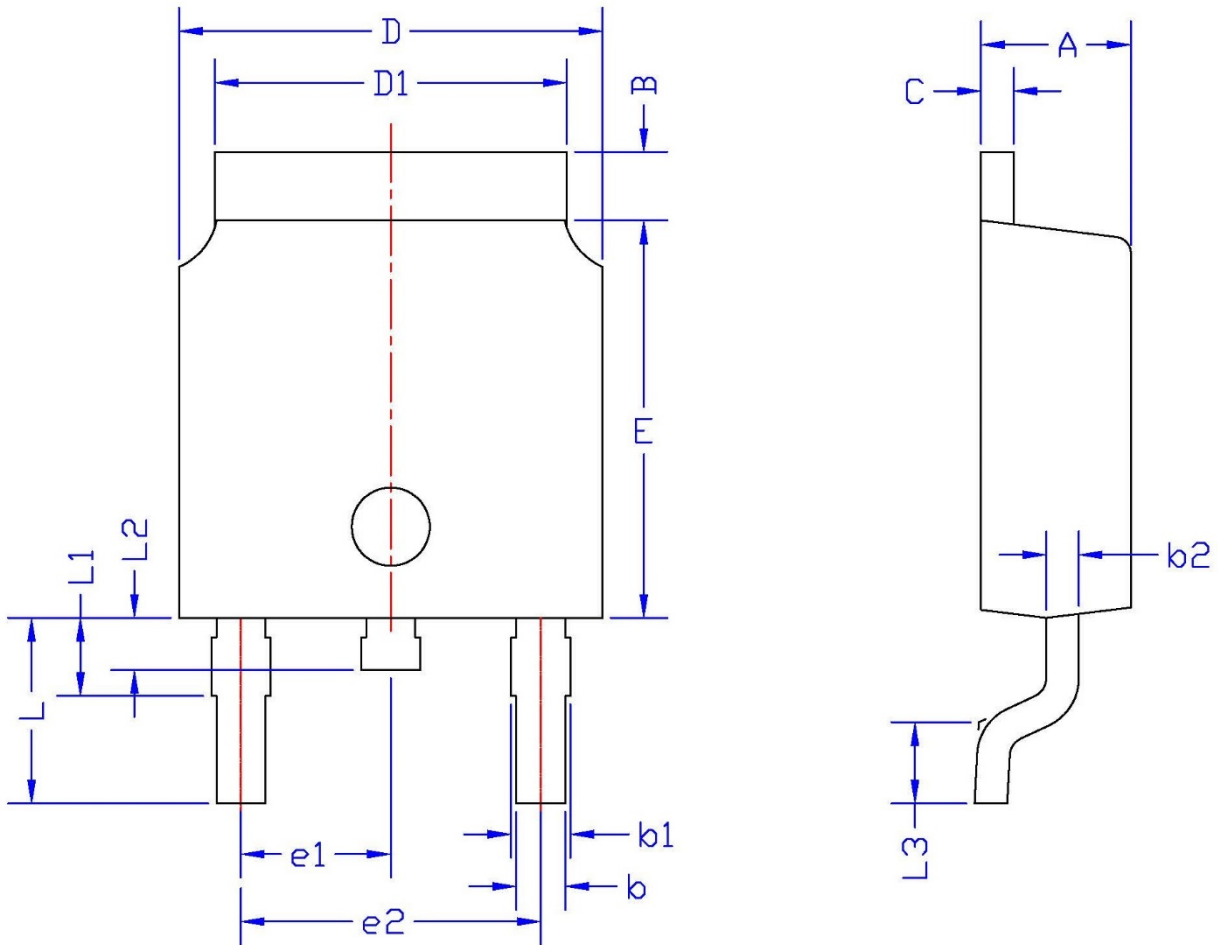
Figure 4. Total Capacitance Charge vs. Reverse Voltage



•Dimensions (TO-252)

UNIT:mm

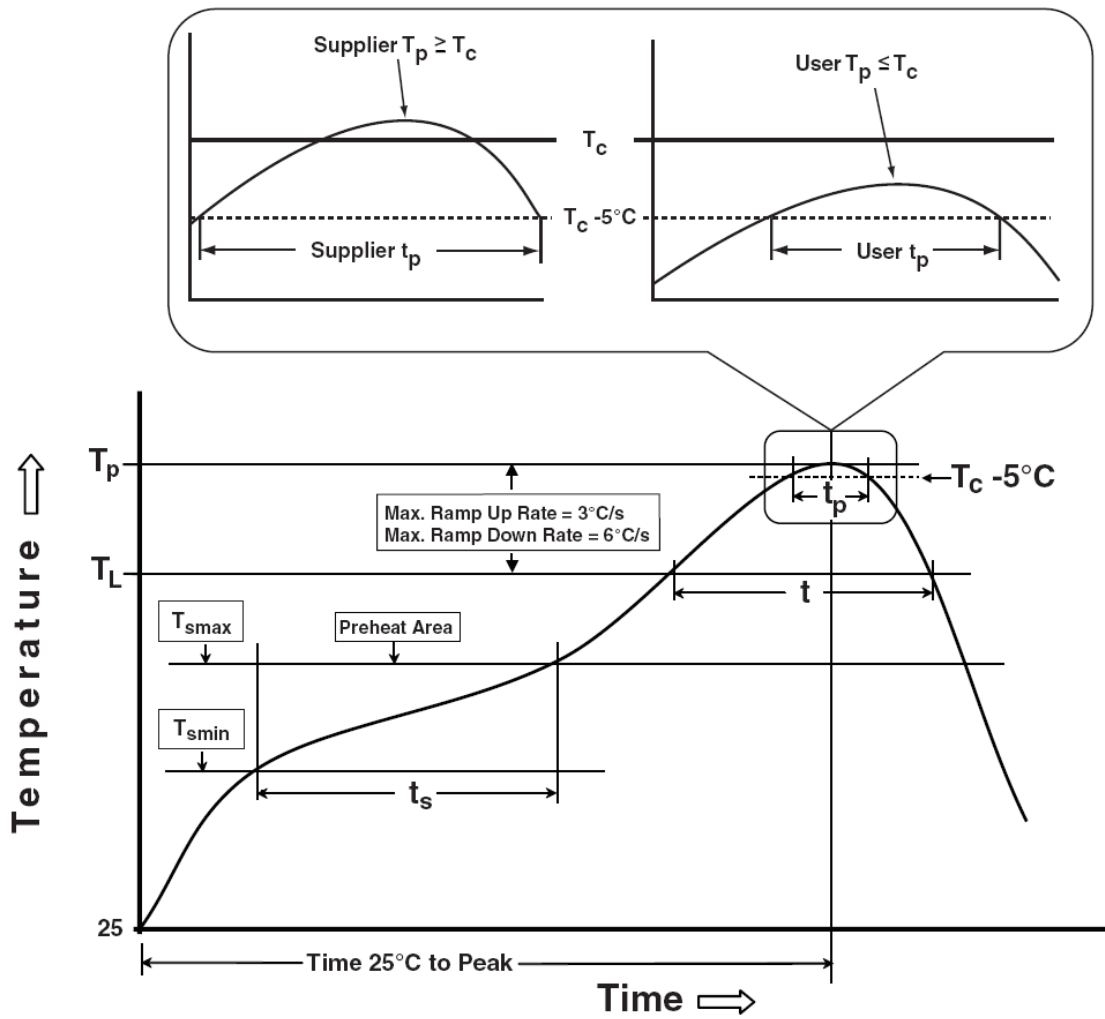
SYMBOL	min	max	SYMBOL	min	max
A	2.10	2.50	L2	0.60	1.20
b	0.50	0.90	L3	1.20	1.80
b1	0.70	1.20	B	0.80	1.30
b2	0.40	0.70	C	0.40	0.70
D	6.20	6.80	D1	5.10	5.60
E	5.80	6.40	e1	2.10	2.45
L	2.60	3.60	e2	4.40	4.80
L1	0.80	1.60			



● **Mechanical**

- Molder Plastic: UL Flammability Classification Rating 94V-0

● **Classification Profile**



● Classification Reflow Profiles

Average ramp-up rate (T_L to T_P)	<3°C/sec	<3°C/sec
Preheat		
- Temperature Min ($T_{S_{min}}$)	100°C	150°C
- Temperature Max ($T_{S_{max}}$)	150°C	200°C
- Time (min to max) (ts)	60 to 120 sec	60 to 180 sec
$T_{S_{max}}$ to T_L		
- Ramp-up Rate	<3°C/sec	<3°C/sec
Time maintained above:		
- Temperature (T_L)	183°C	217°C
- Time (t_L)	60 to 150 sec	60 to 150 sec
Peak Temperature (T_P)	240°C +0/-5°C	260°C +0/-5°C
Time within 5°C of actual Peak Temperature (t_P)	10 to 30 sec	20 to 40 sec
Ramp-down Rate	<6°C/sec	<6°C/sec
Time 25°C to Peak Temperature	<6 minutes	<8 minutes

Flow (wave) soldering (solder dipping)

Products	Peak Temperature	Dipping Time
Pb devices.	245°C ±5°C	5sec ±1sec
Pb-Free devices.	260°C +0/-5°C	5sec ±1sec

● Reliability Test Program

Testitem	Method	Description
Solderability	JESD-22,B102	5sec , 245°C
Holt	JESD-22,A108	1000Hrs,Bias@125°C
PCT	JESD-22,A102	168Hrs,100%RH,2atm,121°C
TCT	JESD-22,A104	500Cycles, -65°C ~150°C